

NOTE:

- MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, SQ=0.40±0.03MM
- FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u")MIN Ni OVER ALL
- SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
- THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 10 SEC. IN A CONVECTION INFRA-RED
OR VAPOR PHASE REFLOW OVEN.
- PRODUCT NUMBERING:
20021621 - 0 0 0 XX X X LF

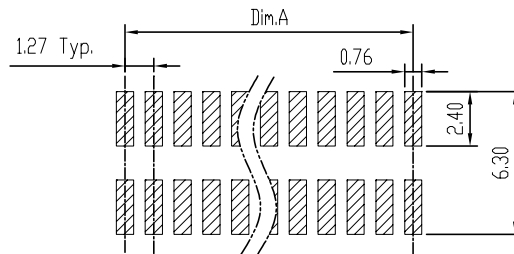
LEAD FREE

PLATING:
1:GOLD FLASH ALL OVER
4:0.25um(10U")GOLD AT CONTACT
8:0.76um(30U")GOLD AT CONTACT
9:1u" GOLD OVER 30u" PdNi AT CONTACT

PACKING
T: TUBE
D: TUBE + CAP
C: T&R + CAP (30 POS)
PIN COUNT
SEE TABLE 1

TABLE 1

DASH No.	Dim.	Amount of Pins	Dim.A	Dim.B	Dim.C
-000 06 XX LF	6	6	2.54	18.31	8.46
-000 10 XX LF	10	10	5.08	20.85	11.00
-000 12 XX LF	12	12	6.35	22.12	12.27
-000 14 XX LF	14	14	7.62	23.39	13.54
-000 16 XX LF	16	16	8.89	24.66	14.81
-000 20 XX LF	20	20	11.43	27.20	17.35
-000 26 XX LF	26	26	15.24	31.01	21.16
-000 30 XX LF	30	30	17.78	33.55	23.70
-000 34 XX LF	34	34	20.32	36.09	26.24
-000 40 XX LF	40	40	24.13	39.90	30.05
-000 44 XX LF	44	44	26.67	42.44	32.59
-000 50 XX LF	50	50	30.48	46.25	36.40
-000 60 XX LF	60	60	36.83	52.60	42.75
-000 64 XX LF	64	64	39.37	55.14	45.29
-000 66 XX LF	66	66	40.64	56.41	46.56
-000 68 XX LF	68	68	41.91	57.68	47.83



mat'l. code		surface ISO1302		tolerance ISO1101 ISO406		projection		product family	
ltr		ecn no		dr		date		MINITEK	
A		T09-1117		S.LIN		09/15/09		title	
B		T10-0027		S.LIN		01/20/10		1.27X1.27MM BTB EJECT HEADER	
C		T-005600		S.LIN		01/18/12		SMT	
D		BX-N-010367		ZK		01/16/12		scale 2:1	
E		BX-N-010623		ZK		02/12/12		dwg no	
				eng		STERLING LIN		sheet 1 of 1	
				chr		GRAY HSIEH		size	
				appd		JOSEPH		20021621	
								A4	
sheet index		revision		E				type	
1		1						Product Customer Drawing	